

IEEE Journal of Radio Frequency Identification

IEEE JRFID Special Issue on AMES 2026



This special issue aims to showcase extended versions of research presented at the **2nd Annual International Conference on Additively Manufactured Electronic Systems (AMES 2026)**, held on September 14–15, 2026, in Leuven, Belgium.

Submissions should provide greater depth and detail, meeting the standards of archival journal publications. All submitted manuscripts will undergo the same peer-review process as regular JRFID submissions.

SUBMISSION DEADLINE

31 December 2026

Early submissions are strongly encouraged. Accepted manuscripts will be published on IEEE Xplore under the topic **“Selected Papers from the 2026 International Conference on Additively Manufactured Electronic Systems”** as soon as the authors submit the final files.

SUBMISSION REQUIREMENTS

The manuscript must significantly extend the conference full-paper by adding substantial new technical content and research results. A similarity score below 30% is mandatory.

The conference paper must be included in the reference list and clearly cited in the manuscript.

The manuscript must clearly identify and discuss all substantial differences from the conference paper. The cover letter must also explain how the manuscript extends the conference paper and summarize the new technical contributions.

The manuscript must have a title different from that of the conference paper to avoid potential copyright issues.

ABOUT IEEE JRFID

IEEE Journal of Radio Frequency Identification (JRFID) is the flagship journal (Hybrid Open Access) of the IEEE CRFID. JRFID has recently achieved remarkable success and outstanding metrics, solidifying its position as a leading publication in the field of communication, localization, wireless power transfer, and sensing.

2025 Impact Factor: 3.7

2025 Cite Score: 8.4

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